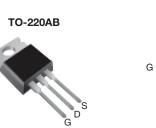


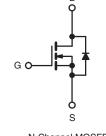
**Vishay Siliconix** 



## **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	1000				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V 5.0				
Q <sub>g</sub> (Max.) (nC)	80				
Q <sub>gs</sub> (nC)	10				
Q <sub>gd</sub> (nC)	42				
Configuration	Single				





N-Channel MOSFET

#### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- · Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

#### DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	IRFBG30PbF			
	SiHFBG30-E3			
SnPb	IRFBG30			
	SiHFBG30			

ABSOLUTE MAXIMUM RATINGS ( $\ensuremath{T_{C}}$	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V <sub>DS</sub>	1000	V	
Gate-Source Voltage			V <sub>GS</sub>	± 20	V	
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C		3.1		
	VGS AL TO V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	2.0	А	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	12		
Linear Derating Factor				1.0	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	280	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	3.1	А	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	13	mJ	
Iaximum Power Dissipation $T_{C} = 25 \ ^{\circ}C$			PD	125	W	
Peak Diode Recovery dV/dtc			dV/dt	1.0	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for	10 s		300 <sup>d</sup>		
	6-32 or M3 screw			10	lbf ∙ in	
Mounting Torque				1.1	N · m	

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD}$  = 50 V, starting T<sub>J</sub> = 25 °C, L = 55 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 3.1 A (see fig. 12).

c.  $I_{SD} \leq 3.1$  A, dI/dt  $\leq 80$  A/µs,  $V_{DD} \leq 600$ ,  $T_J \leq 150$  °C.

d. 1.6 mm from case.

\* Pb containing terminations are not RoHS compliant, exemptions may apply

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COMPLIANT

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THERMAL RESISTANCE RATINGS									
PARAMETER	SYMBOL	TYP.		MAX.		UNIT			
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-		62 - 1.0					
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.50				°C/W			
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-							
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 $^{\circ}$ C, u	nless otherw	ise noted)							
PARAMETER	SYMBOL	TEST	CONDIT	IONS	MIN.	TYP.	MAX.	UNIT	
Static									
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0$	) V, I <sub>D</sub> = 2	250 µA	1000	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C	, I <sub>D</sub> = 1 mA	-	1.4	-	V/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V$	/ <sub>GS</sub> , I <sub>D</sub> = 2	250 µA	2.0	-	4.0	V	
Gate-Source Leakage	I <sub>GSS</sub>	VG	<sub>iS</sub> = ± 20	V	-	-	± 100	nA	
Zero Gate Voltage Drain Current	1	V <sub>DS</sub> = 10	000 V, Vo	<sub>GS</sub> = 0 V	-	-	100		
Zero Gale voltage Drain Gurrent	IDSS	V <sub>DS</sub> = 800 V, V	$V_{DS}$ = 800 V, $V_{GS}$ = 0 V, $T_{J}$ = 125 °C		-	-	500	μA	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V I <sub>D</sub> = 1.9 A <sup>b</sup>		-	-	5.0	Ω		
Forward Transconductance	9 <sub>fs</sub>	$V_{DS} = 10 \text{ V}, I_D = 1.9 \text{ A}^{b}$		2.1	-	-	S		
Dynamic	_					_			
Input Capacitance	C <sub>iss</sub>	V	′ <sub>GS</sub> = 0 V	,	-	980	-		
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 25 V,		-	140	-	pF		
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0 MHz, see fig. 5		-	50	-			
Total Gate Charge	Qg				-	-	80		
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 3.1 \text{ A}, V_{DS} = 400 \text{ V},$ see fig. 6 and $13^{\text{b}}$		-	-	10	nC	
Gate-Drain Charge	Q <sub>gd</sub>				-	-	42		
Turn-On Delay Time	t <sub>d(on)</sub>		•		-	12	-		
Rise Time	t <sub>r</sub>	V <sub>DD</sub> = 5	$V_{DD} = 500 \text{ V}, I_D = 3.1 \text{ A}$		-	25	-	1	
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_g = 12 \Omega$ , $R_D = 170 \Omega$ , see fig. $10^b$		-	89	-	- ns		
Fall Time	t <sub>f</sub>			-	29	-			
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-			
Internal Source Inductance	L <sub>S</sub>			-	7.5	-	- nH		
Drain-Source Body Diode Characteristic	cs								
Continuous Source-Drain Diode Current	١ <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	3.1	A		
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	12	-		
Body Diode Voltage	$V_{SD}$	$T_J = 25 \ ^{\circ}\text{C}, \ I_S = 3.1 \ \text{A}, \ V_{GS} = 0 \ V^b$		-	-	1.8	V		
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T₁ = 25 °C I⊨ −	3.1 A di	/dt = 100 A/us <sup>b</sup>	-	410	620	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = 3.1 A, dl/dt = 100 A/μs <sup>b</sup>		-	1.3	2.0	μC		
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-			i-on is dor	minated b	y L <sub>S</sub> and	L <sub>D</sub> )	

#### Notes

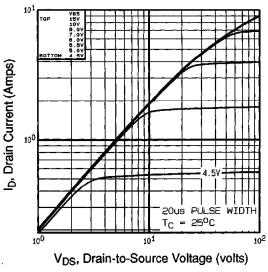
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$ 

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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



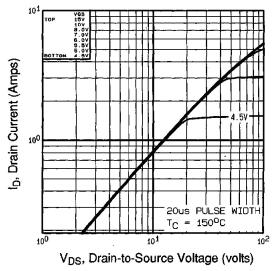


Fig. 2 - Typical Output Characteristics,  $T_C$  = 150 °C

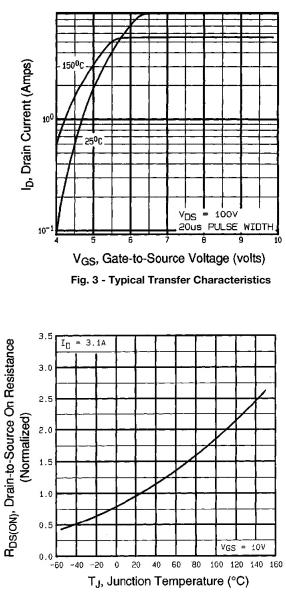


Fig. 4 - Normalized On-Resistance vs. Temperature

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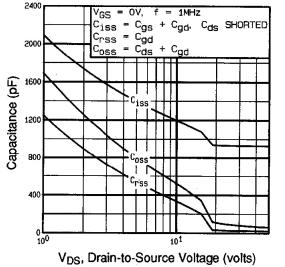
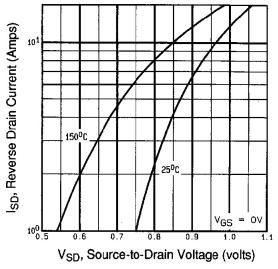
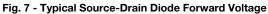


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





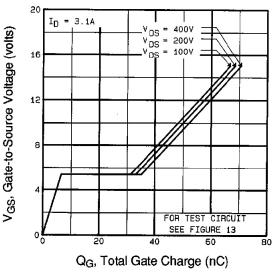
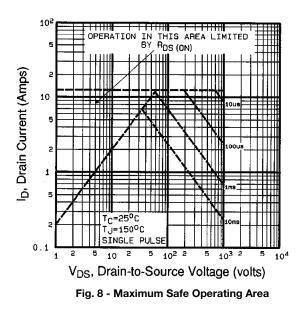


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



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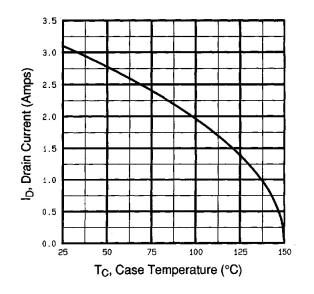


Fig. 9 - Maximum Drain Current vs. Case Temperature

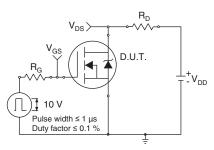


Fig. 10a - Switching Time Test Circuit

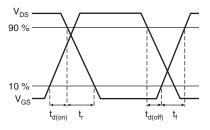


Fig. 10b - Switching Time Waveforms

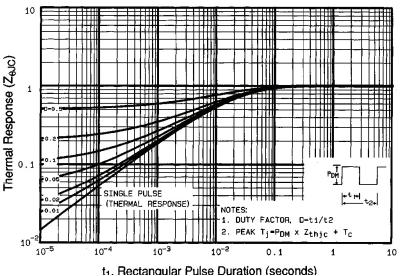


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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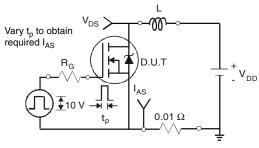


Fig. 12a - Unclamped Inductive Test Circuit

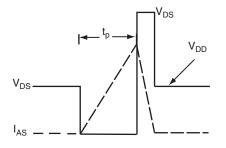


Fig. 12b - Unclamped Inductive Waveforms

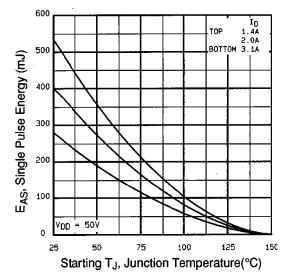


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

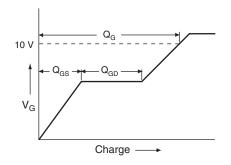
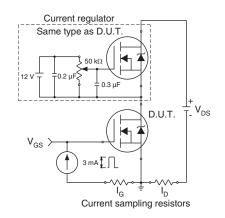
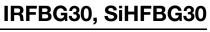


Fig. 13a - Basic Gate Charge Waveform





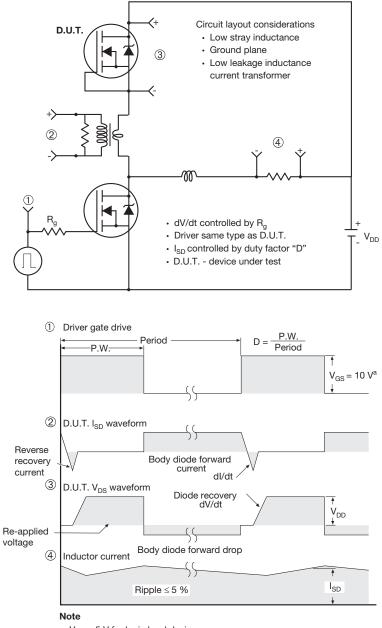
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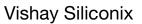


a.  $V_{GS}$  = 5 V for logic level devices

Fig. 14 - For N-Channel

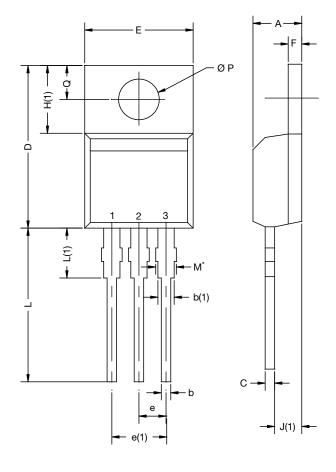
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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

-  $M^{\star}$  = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture						
ASE		Xi'an				
		IRF 9510 744K AB				

Revison: 14-Dec-15

1 For technical questions, contact: <u>hvm@vishay.com</u> Document Number: 66542

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